

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE



**Field Device Integration (FDI®) –  
Part 7: Communication Devices**

**Intégration des appareils de terrain (FDI®) –  
Partie 7: Appareils de Communication**





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# INTERNATIONAL ELECTROTECHNICAL COMMISSION

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## FIELD DEVICE INTEGRATION (FDI®) –

### Part 7: Communication Devices

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This third edition cancels and replaces the second edition published in 2021. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) added ScanExtended Method.

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Draft	Report on voting
65E/859/CDV	65E/916/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described in greater detail at [www.iec.ch/publications](http://www.iec.ch/publications).

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